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## **ON Semiconductor**®

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### N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET **100 V, 78 A, 7.2 m**Ω

#### Features

- Shielded Gate MOSFET Technology
- Max  $r_{DS(on)} = 7.2 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 28 \text{ A}$
- Max r<sub>DS(on)</sub> = 19.5 mΩ at V<sub>GS</sub> = 6 V, I<sub>D</sub> = 14 A
- 50% Lower Qrr than Other MOSFET Suppliers
- Lowers Switching Noise/EMI
- MSL1 Robust Package Design
- 100% UIL Tested
- RoHS Compliant

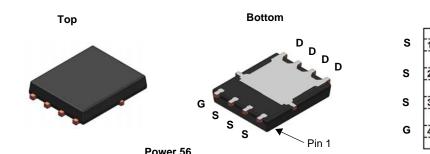


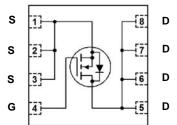
#### **General Description**

This N-Channel MV MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that incorporates Shielded Gate technology. This process has been optimized to minimize on-state resistance and yet maintain superior switching performance with best in class soft body diode.

#### Applications

- Primary DC-DC MOSFET
- Synchronous Rectifier in DC-DC and AC-DC
- Motor Drive
- Solar





Power 56

#### **MOSFET Maximum Ratings** T<sub>A</sub> = 25 °C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	78		
	-Continuous	T <sub>C</sub> = 100 °C	(Note 5)	49	^	
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	13	Α	
	-Pulsed		(Note 4)	364		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	216	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		83		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.5		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case	1.5	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86182	FDMS86182	Power 56	13 "	12 mm	3000 units

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2016

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V
$\Delta BV_{DSS} \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		56		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V},  V_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 150 μA	2.0	3.2	4.0	V
$\Delta V_{GS(th)} \Delta T_J$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 150 \ \mu\text{A}$ , referenced to 25 °C		-9		mV/°C
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 28 A		5.9	7.2	
		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 14 A		9.3	19.5	mΩ
		$V_{GS}$ = 10 V, $I_{D}$ = 28 A, $T_{J}$ = 125 °C		9.9	12.1	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 28 A		63		S
-	Characteristics					
C <sub>iss</sub>	Input Capacitance			1880	2635	pF
C <sub>oss</sub>	Output Capacitance	─ V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1105	1550	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			13	25	pF
R <sub>g</sub>	Gate Resistance		0.1	0.5	1.2	Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			13	24	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 28 A,		4	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		18	33	ns
t <sub>f</sub>	Fall Time			4	10	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		26	37	nC
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to } 6 \text{ V}$ $V_{DD} = 50 \text{ V},$		17	24	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 28 A		8.2		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.1		nC
Q <sub>oss</sub>	Output Charge	$V_{DD} = 50 \text{ V}, V_{GS} = 0 \text{ V}$		73		nC
Drain-Sou	urce Diode Characteristics					
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.7	1.2	- V
		V <sub>GS</sub> = 0 V, I <sub>S</sub> = 28 A (Note 2)		0.8	1.3	
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 14 A, di/dt = 300 A/μs		28	45	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$F = 14 \Lambda$ , $u/u = 300 \Lambda/\mu$		52	84	nC
t <sub>rr</sub>	Reverse Recovery Time	— I <sub>F</sub> = 14 A, di/dt = 1000 A/μs		22	36	ns
Qrr	Reverse Recovery Charge	$r_{\rm F} = 1 + 7.$ , u/u = 1000 7/µ3		116	186	nC

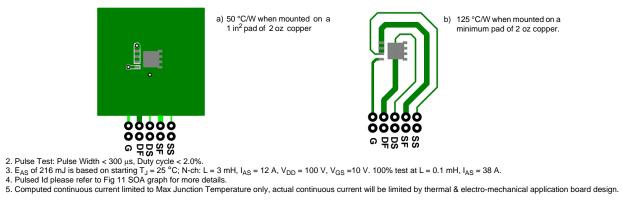
Q<sub>rr</sub> Notes:

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FDMS86182 Rev. 1.0

1. R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0CA</sub> is determined by the user's board design.

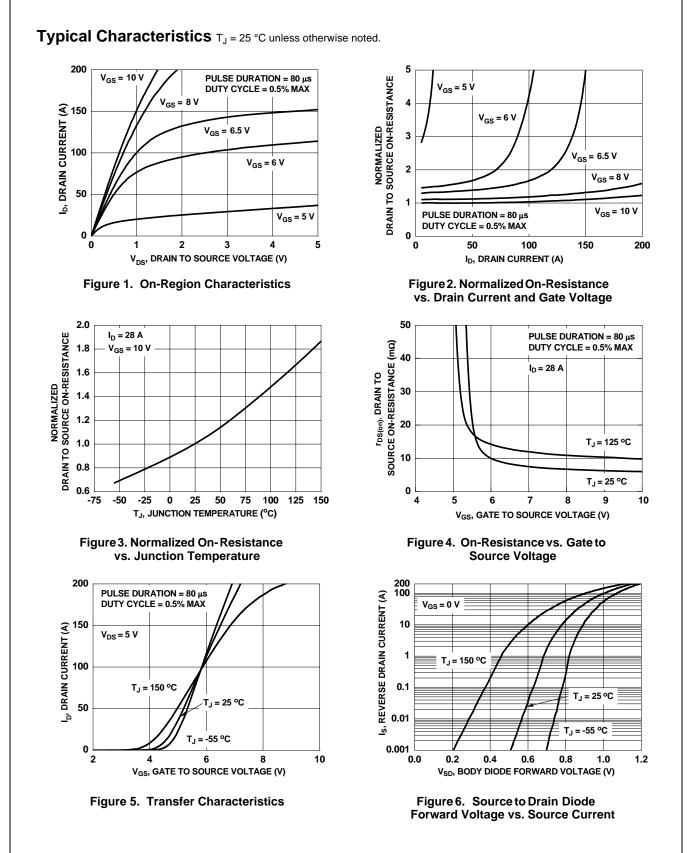
a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

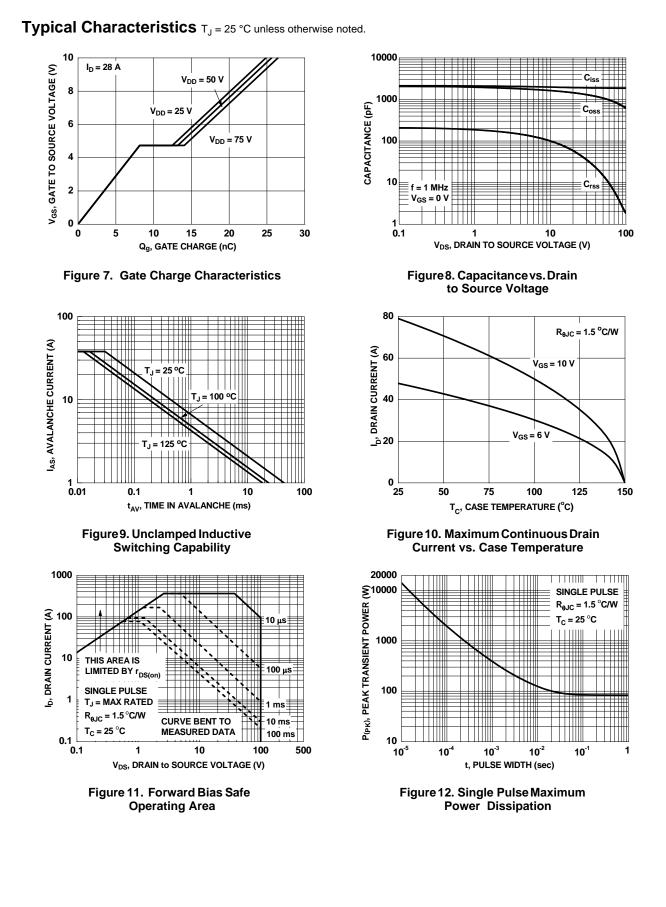


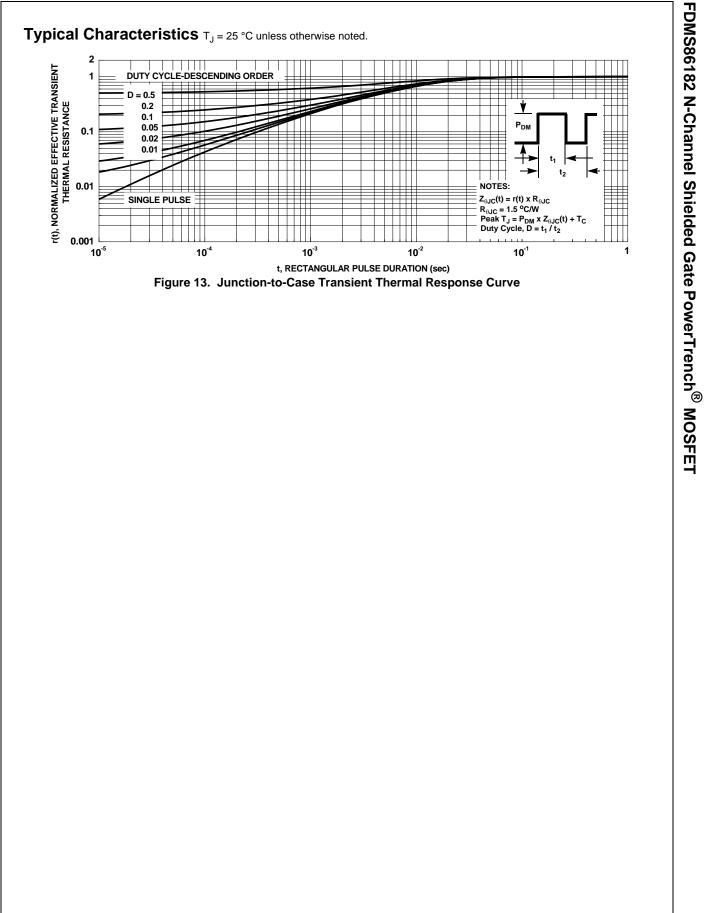
Reverse Recovery Charge

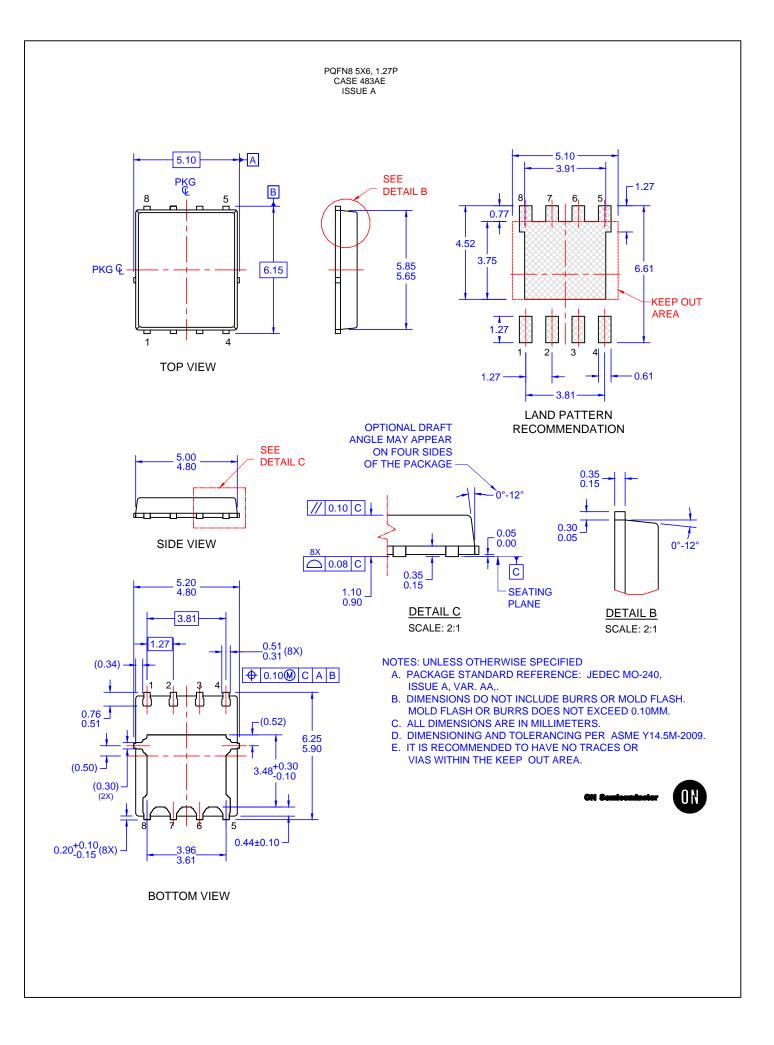


b) 125 °C/W when mounted on a minimum pad of 2 oz copper.









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